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STS8DN3LLH5

Dual N-channel 30 V, 0.0155 Ω, 10 A, SO-8 STripFET™ V Power MOSFET

Features

Туре	V _{DSS} R _{DS(on)} max		I _D
STS8DN3LLH5	30 V	< 0.019 Ω	10 A ⁽¹⁾

- 1. The value is rated according $R_{thj-pcb}$
- R_{DS(on)} * Q_g industry benchmark
- Extremely low on-resistance R_{DS(on)}
- Very low switching gate charge
- High avalanche ruggedness
- Low gate drive power losses

Application

Switching applications

Description

This STripFET[™]V Power MOSFET technology is among the latest improvements, which have been especially tailored to achieve very low on-state resistance providing also one of the best-in-class FOM. SO-8

Figure 1. Internal schematic diagram

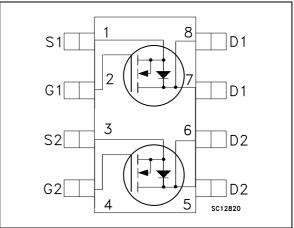


Table 1.Device summary

Order code	Marking	Package	Packaging
STS8DN3LLH5	8DN3LL	SO-8	Tape and reel

Contents

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1 Electrical ratings

Table 2.	Absolute maxim	um ratings
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Symbol	Parameter	Value	Unit
V _{DS}	Drain-source voltage (V _{GS} = 0)	30	V
V _{GS}	Gate-source voltage	± 22	V
I _D ⁽¹⁾	Drain current (continuous) at $T_C = 25 \ ^{\circ}C$	10	А
I _D ⁽¹⁾	Drain current (continuous) at T _C =100 °C	9	Α
I _{DM} ⁽²⁾	Drain current (pulsed)	40	Α
P _{TOT} ⁽²⁾	Total dissipation at $T_C = 25 \ ^{\circ}C$	2.7	W
	Derating factor	0.02	W/°C
T _J T _{stg}	Operating junction temperature Storage temperature	-55 to 150	°C

1. The value is rated according $R_{thj\text{-}pcb}$

2. Pulse width limited by safe operating area

Table 3. Thermal resistance

Symbol	Parameter	Value	Unit
R _{thj-pcb} ⁽¹⁾	Thermal resistance junction-ambient	47	°C/W

1. When mounted on FR-4 board of 1inch², 2oz Cu, t < 10sec



2 Electrical characteristics

(T_{CASE}=25°C unless otherwise specified)

	On/on states					
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$I_{D} = 250 \ \mu A, \ V_{GS} = 0$	30			V
I _{DSS}	Zero gate voltage drain current (V _{GS} = 0)	V _{DS} = max rating, V _{DS} =max rating @125 °C			1 10	μΑ μΑ
I _{GSS}	Gate body leakage current (V _{DS} = 0)	$V_{GS} = \pm 22 V$			±100	nA
V _{GS(th)}	Gate threshold voltage	V_{DS} = V_{GS} , I_D = 250 μ A	1			V
R _{DS(on)}	Static drain-source on resistance	V _{GS} = 10 V, I _D = 5 A V _{GS} = 4.5 V, I _D = 5 A		0.0155 0.020	0.019 0.022	Ω Ω

Table 4. On/off states

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{iss} C _{oss} C _{rss}	Input capacitance Output capacitance Reverse transfer capacitance	V _{DS} = 25 V, f=1 MHz, V _{GS} =0	-	724 132 21		pF pF pF
Q _g Q _{gs} Q _{gd}	Total gate charge Gate-source charge Gate-drain charge	V _{DD} =15 V, I _D = 10 A V _{GS} = 4.5 V <i>Figure 14</i>	-	5.4 2 2.1		nC nC nC
R _G	Intrinsic gate resistance	f=1 MHz gate dc bias=0 test signal level = 20 mV open drain	-		3.3	Ω



Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)} t _r t _{d(off)} t _f	Turn-on delay time Rise time Turn-off delay time Fall time	V_{DD} =15 V, I _D = 5 A, R _G =4.7 Ω, V _{GS} =10 V <i>Figure 13</i>	-	4 4.2 21.1 3.5	-	ns ns ns ns

Table 6.Switching times

Table 7.Source drain diode

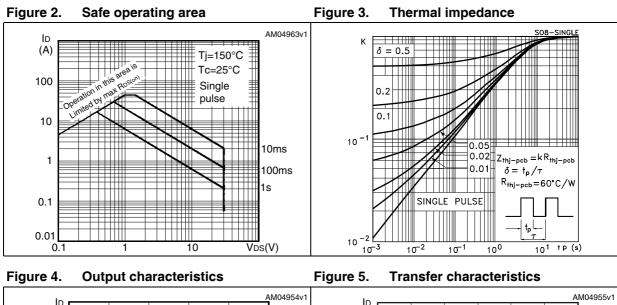
Symbol	Parameter	Test conditions	Min	Тур.	Max	Unit
I _{SD}	Source-drain current		-		10	А
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		40	А
V _{SD} ⁽²⁾	Forward on voltage	I _{SD} = 10 A, V _{GS} =0	-		1.1	V
t _{rr}	Reverse recovery time	I _{SD} = 10 A,		20.8		ns
Q _{rr}	Reverse recovery charge	di/dt = 100 A/µs,	-	10.5		nC
I _{RRM}	Reverse recovery current	V _{DD} = 25 V, Tj=150 °C		1		А

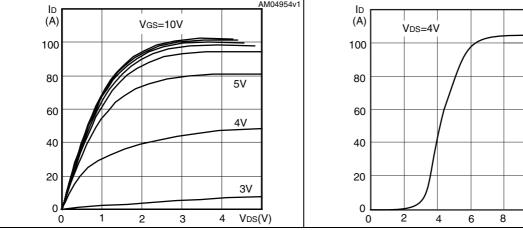
1. Pulse width limited by safe operating area

2. Pulsed: pulse duration=300µs, duty cycle 1.5%



2.1 Electrical characteristics (curves)

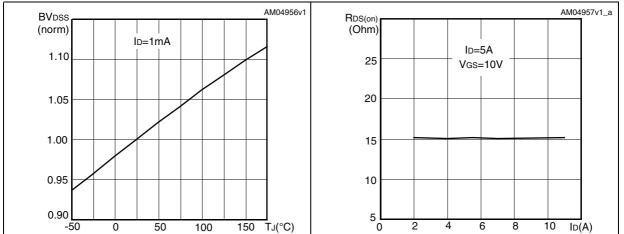






ure 7. Static drain-source on resistance

10 VGs(V)





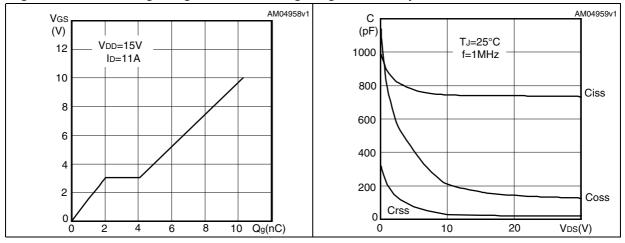


Figure 8. Gate charge vs gate-source voltage Figure 9. Capacitance variations

Figure 10. Normalized gate threshold voltage Figure 11. Normalized on resistance vs vs temperature temperature

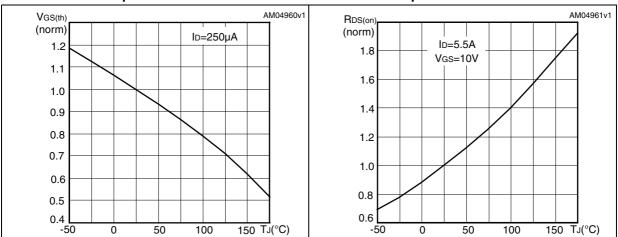
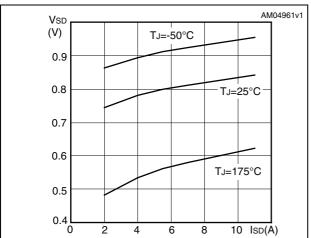


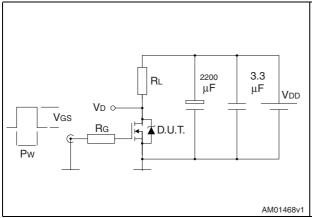
Figure 12. Source-drain diode forward characteristics



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3 Test circuits

Figure 13. Switching times test circuit for resistive load



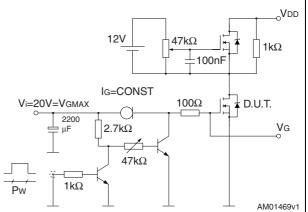
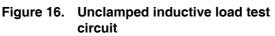
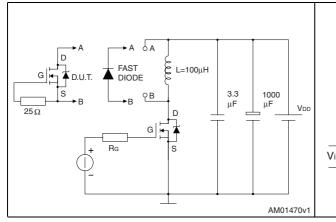
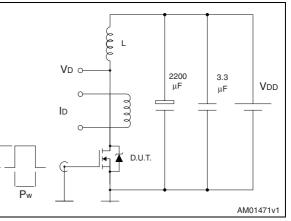


Figure 14. Gate charge test circuit

Figure 15. Test circuit for inductive load switching and diode recovery times







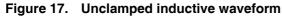
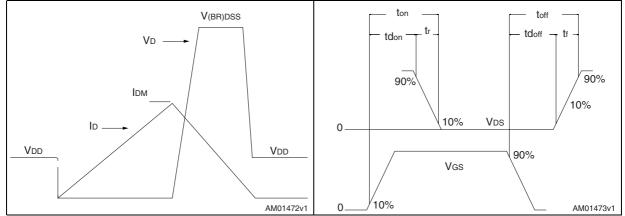


Figure 18. Switching time waveform



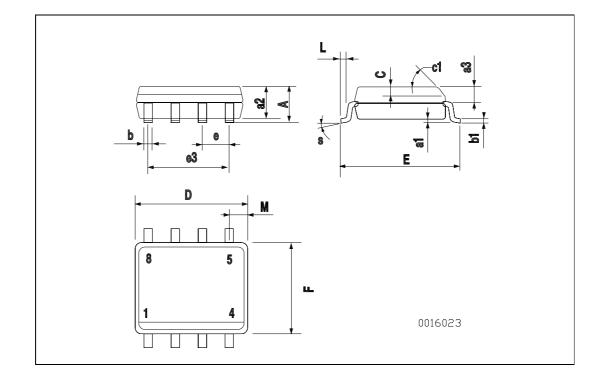


4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.



		SO-8 M	ECHANICA	L DATA		
DIM.		mm.			inch	
DIM.	MIN.	ТҮР	MAX.	MIN.	TYP.	MAX.
А			1.75			0.068
a1	0.1		0.25	0.003		0.009
a2			1.65			0.064
a3	0.65		0.85	0.025		0.033
b	0.35		0.48	0.013		0.018
b1	0.19		0.25	0.007		0.010
С	0.25		0.5	0.010		0.019
c1		•	45 ((typ.)		
D	4.8		5.0	0.188		0.196
E	5.8		6.2	0.228		0.244
е		1.27			0.050	
e3		3.81			0.150	
F	3.8		4.0	0.14		0.157
L	0.4		1.27	0.015		0.050
М			0.6			0.023
S			8 (n	nax.)	1	1



Doc ID 16967 Rev 1



5 Revision history

Table 8. Document revision history

Date	Revision	Changes
12-Jan-2010	1	First release



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